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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shin HARADA	04/13/2012
Toru HIYOSHI	04/16/2012
Keiji WADA	04/16/2012
Takeyoshi MASUDA	04/19/2012

RECEIVING PARTY DATA

Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.	
Street Address:	5-33, Kitahama 4-chome, Chuo-ku	
City:	Osaka-shi, Osaka	
State/Country:	JAPAN	
Postal Code:	541-0041	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13512459

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 201917-0156 (485449)

NAME OF SUBMITTER: Peter J. Sistare

Total Attachments: 2

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PATENT REEL: 028281 FRAME: 0034 P \$40.00 13512459

ATTORNEY DOCKET NO.:

SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled: Semiconductor Device and Method for Manufacturing Same				
For which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on				
WHEREAS, <u>Sumitomo Electric Industries</u> , <u>Ltd.</u> , a corporation of <u>Japan</u> , whose post office address is <u>5-33</u> , <u>Kitahama 4-chome</u> , <u>Chuo-ku</u> , <u>Osaka-shi</u> , <u>Osaka 541-0041 Japan</u> , (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;				
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;				
AND, I/WE HEREBY further covenar communicate with assignee, its successors and invention and testify in any legal proceeding, and deliver all papers that may be necessary cassignee, its successors and assigns, execute a all rightful oaths and generally do everything and enforce proper patent protection for this i expense incident to the execution of such papers.	sign all lawful papers when called upon to or desirable to perfect the title to this inver- ill divisional, continuation, and reissue ap- possible to aid assignee, its successors are invention in the United States, it being und	pecting this o do so, execute ntion in said oplications, make nd assigns, to obtain derstood that any		
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known. IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).				
Full Name of Sole or First Assignor Shin HARADA	Assignor's Signature	Date April 13, 2012		
Address c/o Osaka Works of Sumitomo Electric Industries, Ltd., 1-3, Shimaya 1-chome, Konohana-ku, Osaka-shi, Osaka 554-0024 Japan		Citizenship Japanese		
Full Name of Second Assignor Toru HIYOSHI	Assignor's Signature Sow Alyoshi	Date April 16, 20/2		
Address c/o Osaka Works of Sumitomo Electric Industries, Ltd., 1-3, Shimaya 1-chome, Konohana-ku, Osaka-shi, Osaka 554-0024 Japan		Citizenship Japanese		
Names of additional inventors attached XY	es No			

PATENT REEL: 028281 FRAME: 0035

ATTORNEY DOCKET NO.:

Full Name of Third Assignor Keiji WADA	Assignor's Signature	Date April 16,2012
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Full Name of Fourth Assignor Takeyoshi MASUDA	Assignor's Signature	Date April 19, 20/2
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Full Name of Fifth Assignor	Assignor's Signature	Date
Address	Citizenship	
Full Name of Sixth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached	Yes ⊠No	

PATENT REEL: 028281 FRAME: 0036

RECORDED: 05/29/2012